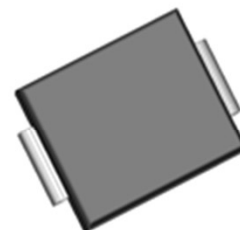


Features

- Schottky barrier diodes
- Low forward voltage drop
- High Junction Temperature
- Moisture sensitivity: level 1, per J-STD-020
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Add suffix "E" for Halogen Free
- Halogen-free according to IEC 61249-2-21 definition



DO-214AB (SMC)

Typical Applications

For use in low voltage, high frequency inverters, free wheeling, and polarity protection application

Maximum Ratings (TA = 25 °C unless otherwise noted)							
Parameter	Symbol	SK52 SK52E	SK53 SK53E	SK54 SK54E	SK55 SK55E	SK56 SK56E	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	V
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	V
Maximum average forward rectified current	$I_{F(AV)}$	5.0					A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	120					A
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 150					°C

Electrical Characteristics (TA = 25 °C unless otherwise noted)								
Parameter	Test Conditions	Symbol	SK52 SK52E	SK53 SK53E	SK54 SK54E	SK55 SK55E	SK56 SK56E	Unit
Maximum instantaneous forward voltage	$I_F=5A, T_A=25^\circ C$	V_F	0.55			0.67		V
Maximum DC reverse current at rated DC blocking voltage	$T_A=25^\circ C$	I_R	0.20			0.15		mA
	$T_A=125^\circ C$		15					
Typical junction capacitance	4.0 V, 1 MHz	C_J	96					pF

Thermal Characteristics							
Parameter	Symbol	SK52 SK52E	SK53 SK53E	SK54 SK54E	SK55 SK55E	SK56 SK56E	Unit
Typical thermal resistance ⁽¹⁾	$R_{\theta JA}$	62			°C/W		
	$R_{\theta JC}$	22					
	$R_{\theta JI}$	15					

Note1: Thermal resistance from junction to lead, mounted on PCB with 8.0×8.0mm copper pads

Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

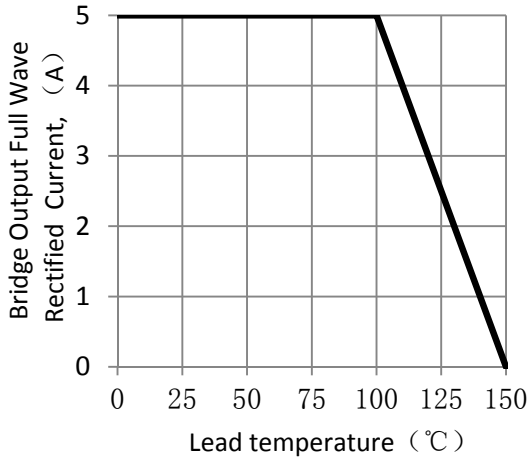


Figure 1. Forward Current Derating Curve

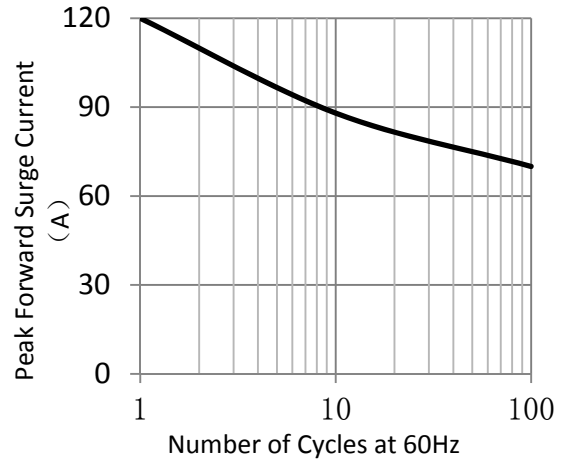


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

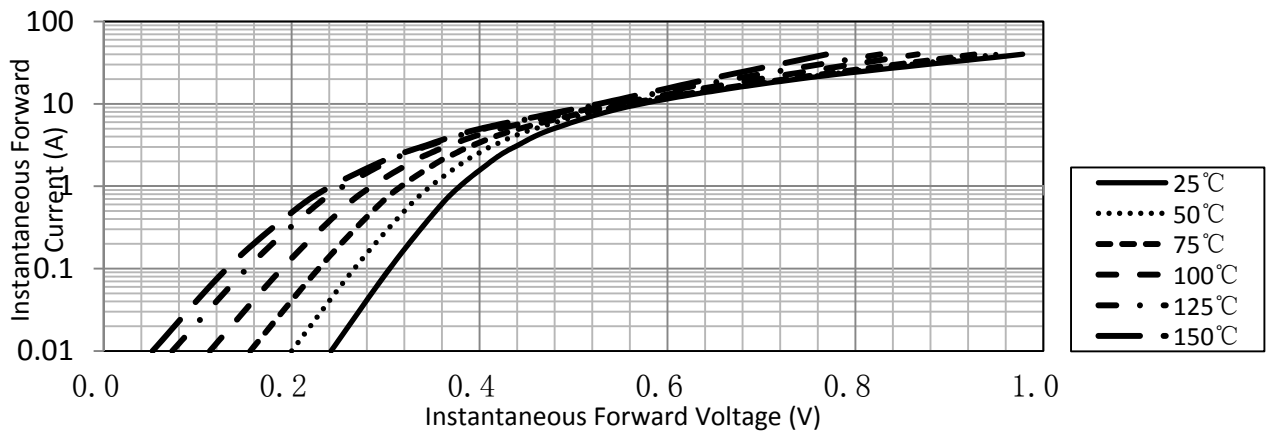


Figure 3. Typical Instantaneous Forward Characteristics (SK52 thru SK54)

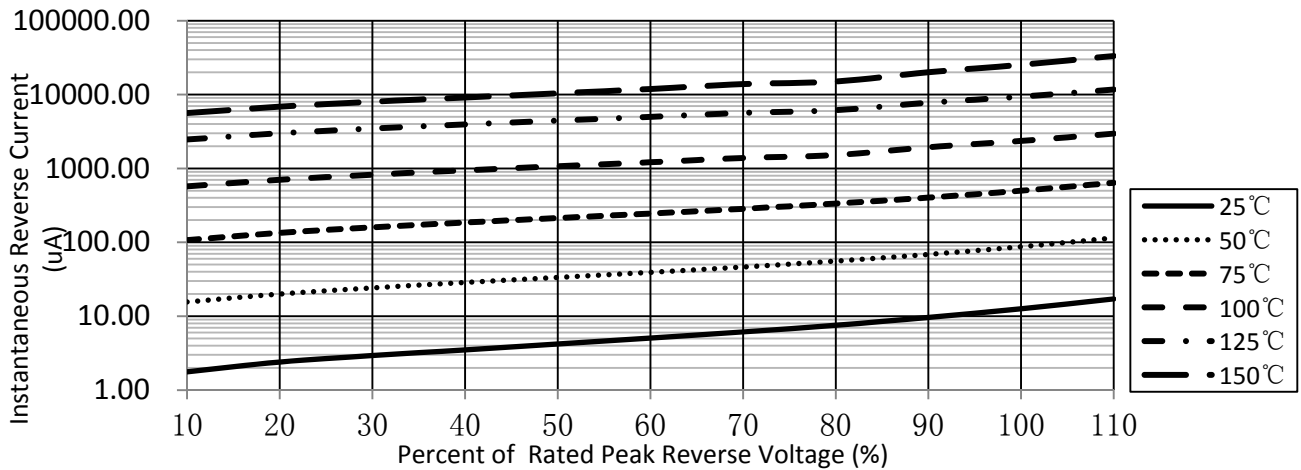


Figure 4. Typical Reverse Characteristics (SK52 thru SK54)

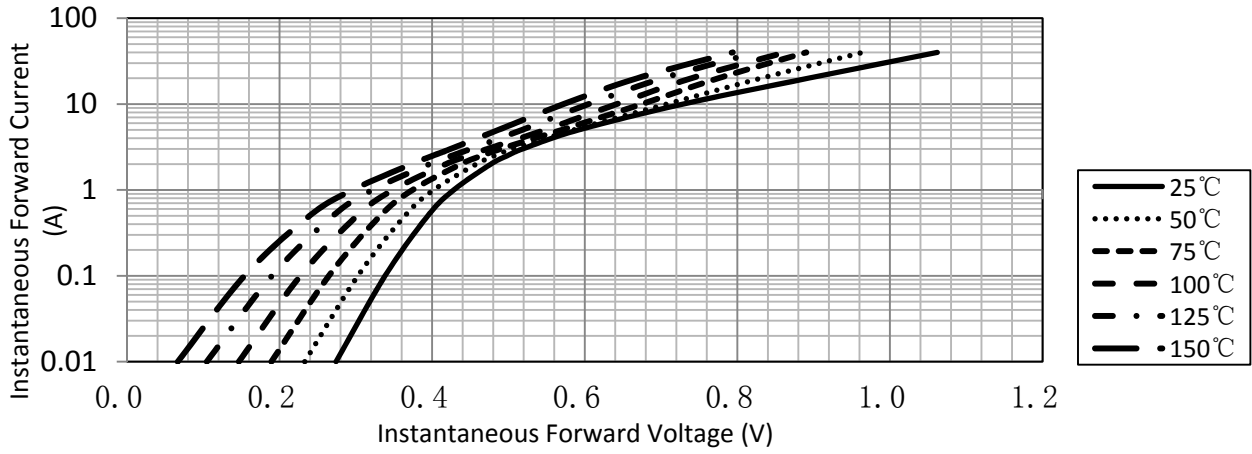


Figure 5. Typical Instantaneous Forward Characteristics (SK55 thru SK56)

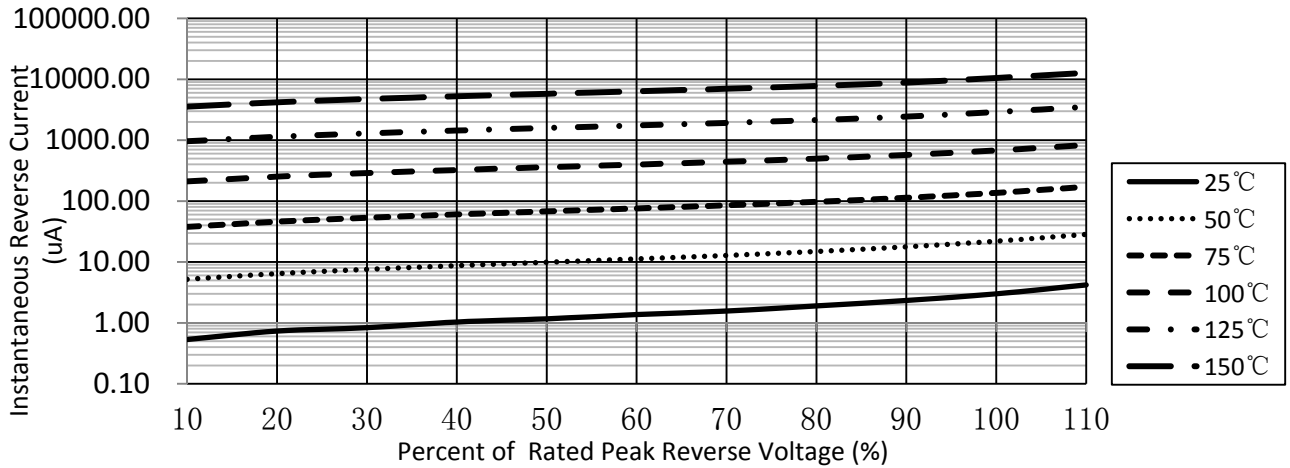
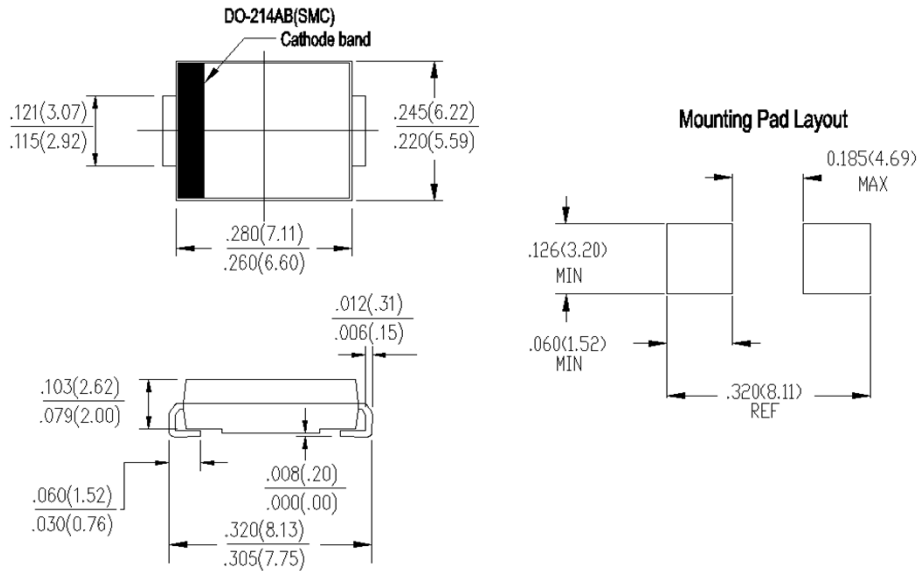


Figure 6. Typical Reverse Characteristics (SK55 thru SK56)

Package Outline Dimensions

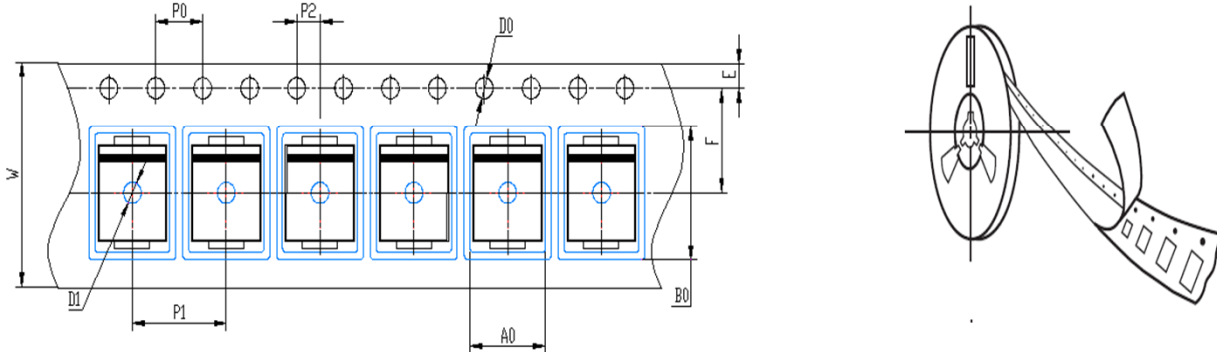
in inches (millimeters)



Packing Information

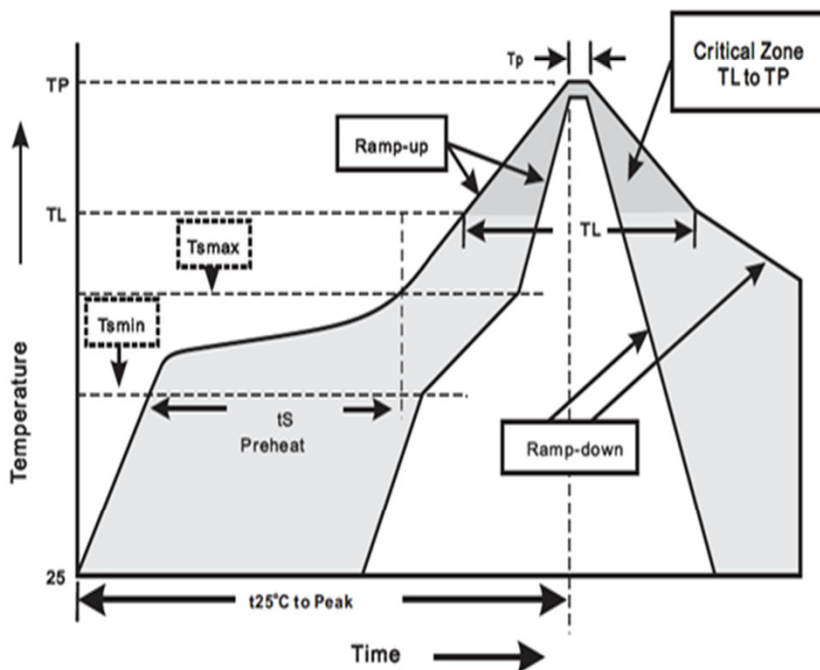
3000 pcs/Reel, 14Reels/Box; 16mm Tape, 13" Reel

Tape & Reel Specification



Symbol	SMC (mm)
W	16 ± 0.2
E	1.75 ± 0.1
F	7.5 ± 0.05
D0	1.5 ± 0.1
D1	1.50 +0.1/-0
P0	4.0 ± 0.1
P1	8.0 ± 0.1
P2	2.0 ± 0.05
A0	6.22 ± 0.1
B0	8.31 ± 0.1

Soldering Parameters



Reflow Soldering		Sn-Pb Eutectic Assembly	Pb-Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	100°C	150°C
	- Temperature Max ($T_{s(max)}$)	150°C	200°C
	- Time (min to max) (t_s)	60 – 120 secs	60 – 180 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak		3°C/second max	3°C/second max
TS(max) to T_L - Ramp-up Rate		3°C/second max	3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	183°C	217°C
	- Time (min to max) (t_s)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T_P)		240+0/-5 °C	240+0/-5°C
Time within 5°C of actual peak Temperature (t_p)		10 – 30 seconds	20 – 40 seconds
Ramp-down Rate		6°C/second max	6°C/second max
Time 25°C to peak Temperature (T_P)		6 minutes Max.	8 minutes Max.
Do not exceed		260°C	260°C

Wave Soldering	
Peak Temperature :	260+0/-5°C
Dipping Time :	10 seconds
Soldering :	1 time



SK52 thru SK56

Surface Mount Schottky Rectifier

Reverse Voltage 20V to 60V Forward Current 5A

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